


- 1 Substrate: 0.0625"±0.007" Fr4/G10 or equivalent high temp material.
- 2 Pins: shell material- Brass; shell finish- 10µ" Gold over contact finish 10µ" Gold over 100µ" Nickel (min.) 50µ" Nickel (min.). Contact material- Beryllium copper;
- 3 Pins: shell material- Brass; finish- 10µ" Gold over 50µ" Nickel (min.).

Description:

Carrier Adaptor: 100 position (0.5mm pitch) QFP Zero insertion force socket with test points to 100 position surface mount leadless QFP emulator foot. The 2 piece adaptor interconnects via a gold plated (0.05" center) Mini-grid socket interface.

Materials and specifications subject to change without notice. All tolerances are ±0.005" unless otherwise specified.

	CA-QFE100S(C,D)-L-N-T-01 Drawing	Status: released	Scale:3:2	Rev: F
	© 1993 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com	Drawing by: P. Jasmine	Date: 2/19/93	
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